

Statement of Compliance

Requested Part

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This declaration covers EU Directive 2011/65/EU incl. Delegated Directive 2015/863/EU.

EU ELV Directive: 2000/53/EC	Compliant with Exemptions 3 - Lead in copper alloy containing up to 4% lead by weight.
China RoHS 2 Directive: MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation:	Current ECHA Candidate List: JAN 2023 (233)
(EC) No. 1907/2006	Candidate List Declared Against: JUN 2020 (209) SVHC > Threshold: Pb (4% in Contact/Component) Article Safe Usage Statements: Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.
Halogen Content:	Not Yet Reviewed for halogen content
Solder Process Capability Code:	Not applicable for solder process capability
TE Connectivity Corporation	

1050 Westlakes Drive

Berwyn, PA 19312

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change.

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked.

Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV).

Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

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Restricted Materials Above Threshold

12 June 2023

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中国电子电气产品中有害物质的名称及含量

China EEP Hazardous Substance Information

部件名称			有	ī害物质			
(Component Name)		1	Hazardous Substance				
225790-4	铅	汞	福	六价铬	多溴联苯	多溴二苯醚	
	(Pb)	(Hg)	(Cd)	(Cr6)	(PBB)	(PBDE)	
连接器系统	Х	0	0	0	0	0	
(Connector Systems)							
本表格依据SJ/T 1136 C: 表示该有害物质在说 Indicates that the c	亥部件所有均质	贡材料中的含量	均在GB/T 265	· 572标准规定的			
O: 表示该有害物质在证	亥部件所有均质	贡材料中的含量	均在GB/T 265	· 572标准规定的	限量要求以下。		
	§部件所有均质 oncentration c	贡材料中的含量 of the hazardo	皆白在GB/T 265 us substance i	· 572标准规定的	限量要求以下。		
D: 表示该有害物质在证 Indicates that the c	亥部件所有均质 oncentration c threshold of th	f材料中的含量 f the hazardou le GB/T 26572	b均在GB/T 265 us substance in 2 standard.	, 72标准规定的 n all homogen	限量要求以下。 eous materials	of the part is	
O: 表示该有害物质在i Indicates that the c below the relevant	亥部件所有均质 oncentration c threshold of th ▷在该部件的身	5材料中的含量 of the hazardoo ne GB/T 26572 其一均质材料中	也均在GB/T 265 us substance in 2 standard. 中的含量超出GB	572标准规定的 n all homogen 3/T 26572标准	限量要求以下。 eous materials 规定的限量要系	of the part is ҟ₀	

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